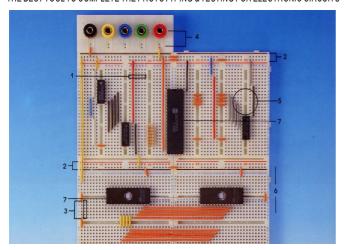
ADVANCED SOLDERLESS BREADBOARD

THE BEST TOOL TO COMPLETE THE PROTOTYPING & TESTING FOR ELECTRONIC CIRCUITS



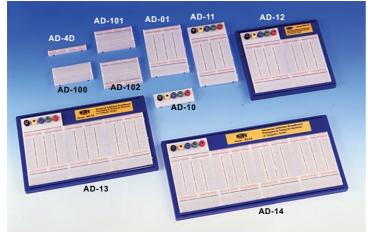
- · More interconnected tie points
- Better structure
- More terminals & power bus
- Easy combination & expansion
- · Easy insertion & wiring
- Very flexible for digital & analog circuits



- 6 interconnected round tie points per row in horizontal array provide an ideal placement and more tie points for MSI, LSI and all DIP size chips in "CPU BUS" connection.
- 2. POWER BUS
 - 2 of 24 each of continual interconnected tie points with black line printing 4 of 12 each of continual interconnected tie points with red line printing & V1, V2, V3, V4 marking individually
- 6 interconnected round tie points per column in vertical array provide an ideal placement and wiring for NON-DIP size components.
- 4. Power block provides 5 individual binding post for easy connection of power bus. (Accept 4.5mm Y-terminal,stripped wire and 4mm banana plug.)
- 5. Interconnected "Round" tie points make your wiring easier. Accept solid wires from AWG # 22-30 (0.3-0.8 mm).
- Vertical combination will offer more wiring spaces for DIP size components.
- 7. The IC chips can be mounted between two AD breadboards when combination.



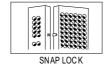
AD SERIES



MATERIAL

External Body is made of ABS.

The internal interconnected clips are Nickel-Plated or Silver-Plated.





SPECIFICATION

MODEL	DIMENSION(m/m)			TIE-	6 interconnected	12 interconnected	24 interconnected	BINDING	BACK-	WEIGHT
	LENGTH	WIDTH	HEIGHT	POINTS	CLIP	CLIP	CLIP	POST	PLATE	(gm)
AD-4D	81	12	9	48	0	2	1	0	STICKER	10
AD-100	81	42	9	360	60	0	0	0	STICKER	30
AD-101	81	52	9	408	60	2	1	0	STICKER	40
AD-102	81	62	9	456	60	4	2	0	STICKER	50
AD-10	81	30	19	10	0	0	0	5	STICKER	20.4
AD-01	83	118	9	948	142	4	2	0	STICKER	77.8
AD-11	83	147	19	958	142	4	2	5	STICKER	98.8
AD-12	184	168	24	1906	284	8	4	5	ABS plastic	254.4
AD-13	266	168	24	2854	426	12	6	5	ABS plastic	367.6
AD-14	346	168	24	3802	568	16	8	5	ABS plastic	490.0